

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX273F, TC74LCX273FK

Low-Voltage Octal D-Type Flip-Flop with Clear with 5-V Tolerant Inputs and Outputs

The TC74LCX273 is a high-performance CMOS octal D-type flip-flop. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low-power dissipation.

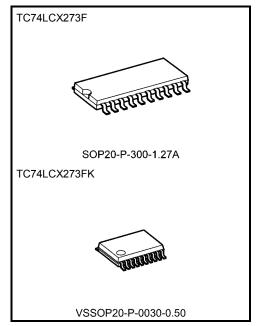
The device is designed for low-voltage $(3.3\ V)\ V_{CC}$ applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

This 8 bit D-type flip-flop is controlled by a clock input (CK) and a clear input ($\overline{\text{CLR}}$). When the $\overline{\text{CLR}}$ input is low, the eight outputs are at a low logic level.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation: $t_{pd} = 8.5 \text{ ns (max) (VCC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current: |IOH|/IOL = 24 mA (min) (VCC = 3.0 V)
- Latch-up performance: $> \pm 500 \text{ mA}$
- Available in JEITA SOP, VSSOP (US)
- · Power-down protection is provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 273 type



Weight

SOP20-P-300-1.27A : 0.22 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

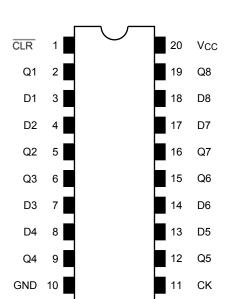
Note: The Electrical Characteristics of V_{CC} = 1.8 \pm 0.15 V is only applicable for products which manufactured from January 2009 onward.

Start of commercial production 2000-02

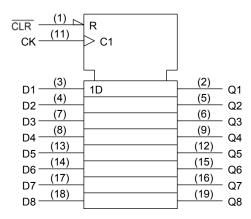
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Pin Assignment (top view)



IEC Logic Symbol

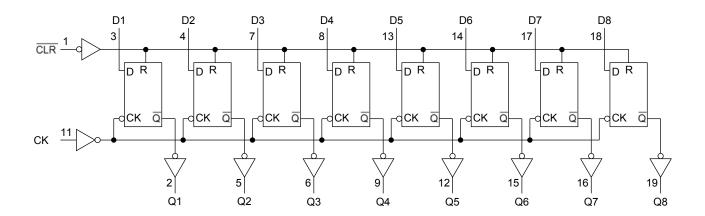


Truth Table

	Inputs	Outputs	Function	
CLR	D	CK	Q	Function
L	Х	Х	L	Clear
Н	L		L	_
Н	Н		Н	_
Н	Х		Qn	No change

X: Don't care

System Diagram





Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	–0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	Vout	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	lıĸ	-50	mA
Output diode current	Іок	±50 (Note 4)	mA
DC output current	Іоит	±50	mA
Power dissipation	PD	180	mW
DC Vcc/ground current	ICC/IGND	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: VCC = 0 V

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: VOUT < GND, VOUT > VCC

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Dowar aupply voltage	Vcc	1.65 to 3.6	V	
Power supply voltage	VCC	1.5 to 3.6 (Note 2)	V	
Input voltage	VIN	0 to 5.5	V	
Output voltage	Vout	0 to 5.5 (Note 3)	V	
Output voltage	٧٥٥١	0 to V _{CC} (Note 4)	V	
Output current	IOH/IOL	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	IIIA	
Operating temperature	Topr	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: VCC = 0 V

Note 4: High or low state

Note 5: VCC = 3.0 to 3.6 V

Note 6: VCC = 2.7 to 3.0 V

Note 7: VIN = 0.8 to 2.0 V, VCC = 3.0 V

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Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	Symbol Test Condition			Min	Max	Unit
Onaraci	icristics	Cyrribor	rest oc	Vcc (V)		IVIIII	IVIAX	Offic
						Vcc×0.9	_	
	H-level	V _{IH}			2.3 to 2.7	1.7	_	
lancit caltaga					2.7 to 3.6	2.0	_	V
Input voltage					1.65 to 2.3	_	Vcc × 0.1	V
	L-level	VIL			2.3 to 2.7	_	0.7	
					2.7 to 3.6	_	0.8	
				IOH = -100 μA	1.65 to 3.6	V _C C-0.2	_	
				I _{OH} = -4 mA	1.65	1.05	_	
	III lawal	Vон	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -8 mA	2.3	1.7	_	V
	H-level			I _{OH} = -12 mA	2.7	2.2	_	
				I _{OH} = -18 mA	3.0	2.4	_	
0				I _{OH} = -24 mA	3.0	2.2	_	
Output voltage			V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.65 to 3.6		0.2	
				I _{OL} = 4 mA	1.65		0.45	
				I _{OL} = 8 mA	2.3	_	0.7	
	L-level	V _{OL}		I _{OL} = 12 mA	2.7	_	0.4	
				I _{OL} = 16 mA	3.0		0.4	
				I _{OL} = 24 mA	3.0		0.55	
Input leakage curr	rent	I _{IN}	V _{IN} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μΑ
Power-off leakage current		loff	VIN/VOUT = 5.5 V		0		10.0	μА
			V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0	
Quiescent supply	current	ICC	V _{IN} = 3.6 to 5.5 V		1.65 to 3.6		±10.0	μΑ
Increase in ICC per input		Δlcc	V _{IN} = V _{CC} - 0.6 V (per 1 input)		2.7 to 3.6		500	



AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Characteristics Symbol Test Condition			Min	Max	Unit
Sharastonistics	5,111001	1331 Sofidition	V _{CC} (V)	141111	IVIAA	Offic
			1.8 ± 0.15	50	_	MHz
Maximum clock frequency	f _{MAX}	(Figure 1, Figure 2)	2.5 ± 0.2	100	—	
Waximum Glock requericy	IWAX	(Figure 1, Figure 2)	2.7	150	_	
	3		3.3 ± 0.3	150	—	
			1.8 ± 0.15	_	30.0	
Propagation delay time (CK-Q)	tPLH	(Figure 1, Figure 2)	2.5 ± 0.2	_	10.5	no
Propagation delay time (CK-Q)	tPHL	(Figure 1, Figure 2)	2.7	_	9.5	ns
			3.3 ± 0.3	1.5	8.5	
			1.8 ± 0.15	_	30.0	
Decrease the delegation (OLD O)		(Figure 4, Figure 9)	2.5 ± 0.2	_	10.5	
Propagation delay time (CLR -Q)	tphL	(Figure 1, Figure 3)	2.7	_	9.5	ns
			3.3 ± 0.3	1.5	8.5	
			1.8 ± 0.15	10.0	_	ns
	tw (H) tw (L)	(Figure 1, Figure 2)	2.5 ± 0.2	5.0	_	
Minimum pulse width (CK)			2.7	3.3	_	
			3.3 ± 0.3	3.3	_	
			1.8 ± 0.15	10.0	_	ns
• • • • • • • • • • • • • • • • • • •			2.5 ± 0.2	5.0	_	
Minimum pulse width (CLR)	t _{W (L)}	(Figure 3)	2.7	3.3	_	
		-		3.3	_	
			1.8 ± 0.15	10.0	_	
			2.5 ± 0.2	5.0	_	
Minimum setup time	ts	(Figure 1, Figure 2)	2.7	2.5	_	ns
			3.3 ± 0.3	2.5	_	
			1.8 ± 0.15	1.5	_	
			2.5 ± 0.2	1.5	_	ns
Minimum hold time	th	(Figure 1, Figure 2)	2.7	1.5	_	
			3.3 ± 0.3	1.5	_	
			1.8 ± 0.15	8.0	_	- ns
			2.5 ± 0.2	4.0	_	
Minimum removal time	t _{rem}	(Figure 4)	2.7	2.5	_	
			3.3 ± 0.3	2.0	_	
	tosLH		2.7	_	_	
Output to output skew	tosHL	(Note)	3.3 ± 0.3	_	1.0	ns

Note: Parameter guaranteed by design.

 $(\mathsf{tosLH} = |\mathsf{tpLHm} - \mathsf{tpLHn}|, \, \mathsf{tosHL} = |\mathsf{tpHLm} - \mathsf{tpHLn}|)$



Dynamic Switching Characteristics

(Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, RL = 500 Ω)

Characteristics	Symbol	Test Condition	Vcc (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Vcc (V)	Тур.	Unit
Input capacitance	CIN		3.3	7	pF
Output capacitance	Cout	_	0	8	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note) 3.3	25	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

ICC (opr) = CPD·VCC·fIN + ICC/8 (per bit)

AC Test Circuit

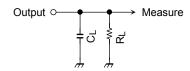


Figure 1

AC Waveform

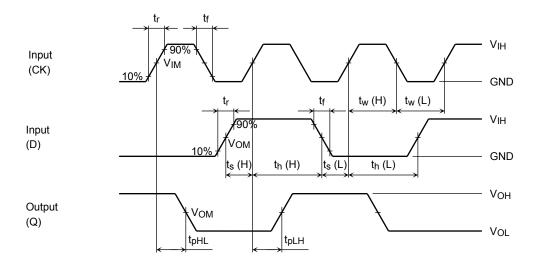


Figure 2 t_{pLH}, t_{pHL}, t_w, t_s, t_h



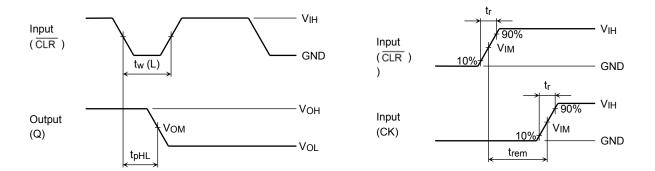


Figure 3 t_{pHL}

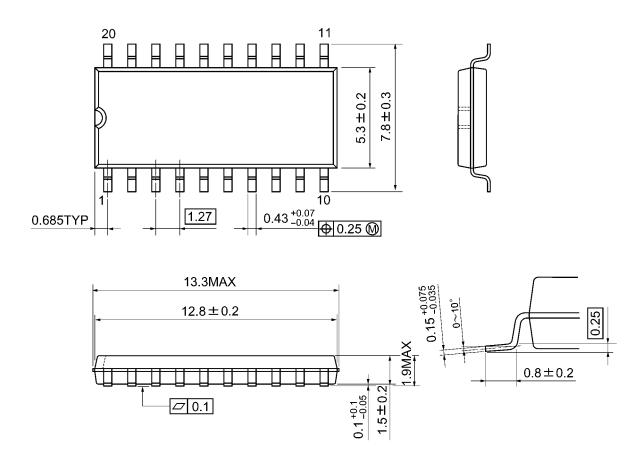
Figure 4 t_{rem}

		Vcc					
	Symbol	$3.3 \pm 0.3 \text{ V}$ 2.7 V	$2.5\pm0.2\textrm{V}$	1.8 ± 0.15 V			
Input	VIH	2.7 V	Vcc	Vcc			
	V _{IM}	1.5 V	V _{CC} /2	V _{CC} /2			
	t _r , t _f	2.5 ns	2.0 ns	2.0 ns			
Output	V _{OM}	1.5 V	V _{OH} /2	V _{OH} /2			
Load	CL	50 pF	30 pF	30 pF			
	RL	500 Ω	500 Ω	1 kΩ			



Package Dimensions

SOP20-P-300-1.27A Unit: mm

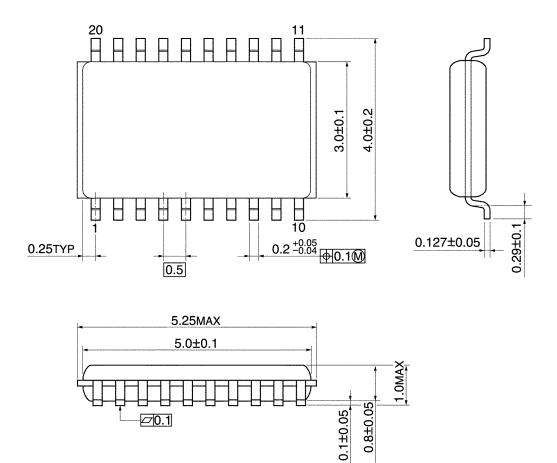


Weight: 0.22 g (typ.)



Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)



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